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Details

Product Status	Active
Core Processor	PIC
Core Size	16-Bit
Speed	32MHz
Connectivity	I ² C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	18
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	512 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24f16kl401-e-ss

PIC24F16KL402 FAMILY

Analog Features:

- 10-Bit, up to 12-Channel Analog-to-Digital (A/D) Converter:
 - 500 ksp/s conversion rate
 - Conversion available during Sleep and Idle
- Dual Rail-to-Rail Analog Comparators with Programmable Input/Output Configuration
- On-Chip Voltage Reference

Special Microcontroller Features:

- Operating Voltage Range of 1.8V to 3.6V
- 10,000 Erase/Write Cycle Endurance Flash Program Memory, Typical
- 100,000 Erase/Write Cycle Endurance Data EEPROM, Typical
- Flash and Data EEPROM Data Retention: 40 Years Minimum
- Self-Programmable under Software Control
- Programmable Reference Clock Output

- Fail-Safe Clock Monitor (FSCM) Operation:
 - Detects clock failure and switches to on-chip, Low-Power RC (LPRC) oscillator
- Power-on Reset (POR), Power-up Timer (PWRT) and Oscillator Start-up Timer (OST)
- Flexible Watchdog Timer (WDT):
 - Uses its own Low-Power RC oscillator
 - Windowed operating modes
 - Programmable period of 2 ms to 131s
- In-Circuit Serial Programming™ (ICSP™) and In-Circuit Emulation (ICE) via 2 Pins
- Programmable High/Low-Voltage Detect (HLVD)
- Programmable Brown-out Reset (BOR):
 - Configurable for software controlled operation and shutdown in Sleep mode
 - Selectable trip points (1.8V, 2.7V and 3.0V)
 - Low-power 2.0V POR re-arm

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PIC24F16KL402 FAMILY

4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® devices and improve data space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address (EA) calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word, which contains the byte, using the LSB of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and the registers are organized as two parallel, byte-wide entities with shared (word) address decode, but separate write lines. Data byte writes only write to the corresponding side of the array or register, which matches the byte address.

All word accesses must be aligned to an even address. Mis-aligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a mis-aligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed, but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the LSB; the MSB is not modified.

A Sign-Extend (SE) instruction is provided to allow the users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users

can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the Near Data Space (NDS). Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the data space is addressable indirectly. Additionally, the whole data space is addressable using MOV instructions, which support Memory Direct Addressing (MDA) with a 16-bit address field. For PIC24F16KL402 family devices, the entire implemented data memory lies in Near Data Space.

4.2.4 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by the module. Much of the SFR space contains unused addresses; these are read as '0'. The SFR space, where the SFRs are actually implemented, is provided in Table 4-2. Each implemented area indicates a 32-byte region, where at least one address is implemented as an SFR. A complete listing of implemented SFRs, including their addresses, is provided in Table 4-3 through Table 4-18.

TABLE 4-2: IMPLEMENTED REGIONS OF SFR DATA SPACE

SFR Space Address									
	xx00	xx20	xx40	xx60	xx80	xxA0	xxC0	xxE0	
000h	Core			ICN	Interrupts				—
100h	Timers	—	TMR	—	—	CCP	—	—	—
200h	MSSP	UART	—	—	—	—	I/O	—	—
300h	A/D			—	—	—	—	—	—
400h	—	—	—	—	—	—	—	ANSEL	—
500h	—	—	—	—	—	—	—	—	—
600h	—	CMP	—	—	—	—	—	—	—
700h	—	—	System	NVM/PMD	—	—	—	—	—

Legend: — = No implemented SFRs in this block.

PIC24F16KL402 FAMILY

FIGURE 8-1: PIC24F INTERRUPT VECTOR TABLE

Decreasing Natural Order Priority ↓	Reset – GOTO Instruction	000000h	Interrupt Vector Table (IVT) ⁽¹⁾
	Reset – GOTO Address	000002h	
	Reserved	000004h	
	Oscillator Fail Trap Vector		
	Address Error Trap Vector		
	Stack Error Trap Vector		
	Math Error Trap Vector		
	Reserved		
	Reserved		
	Reserved		
	Interrupt Vector 0	000014h	
	Interrupt Vector 1		
	—		
	—		
	—		
	Interrupt Vector 52	00007Ch	
	Interrupt Vector 53	00007Eh	
	Interrupt Vector 54	000080h	
	—		
	—		
	—		
	Interrupt Vector 116	0000FCh	
	Interrupt Vector 117	0000FEh	
	Reserved	000100h	
	Reserved	000102h	
	Reserved		
	Oscillator Fail Trap Vector		
	Address Error Trap Vector		
	Stack Error Trap Vector		
	Math Error Trap Vector		
	Reserved		Alternate Interrupt Vector Table (AIVT) ⁽¹⁾
	Reserved		
	Reserved		
	Interrupt Vector 0	000114h	
	Interrupt Vector 1		
	—		
	—		
	—		
	Interrupt Vector 52	00017Ch	
	Interrupt Vector 53	00017Eh	
	Interrupt Vector 54	000180h	
	—		
	—		
	—		
	Interrupt Vector 116		
	Interrupt Vector 117	0001FEh	
	Start of Code	000200h	

Note 1: See Table 8-2 for the interrupt vector list.

PIC24F16KL402 FAMILY

8.3 Interrupt Control and Status Registers

Depending on the particular device, the PIC24F16KL402 family of devices implements up to 28 registers for the interrupt controller:

- INTCON1
- INTCON2
- IFS0 through IFS5
- IEC0 through IEC5
- IPC0 through IPC7, ICP9, IPC12, ICP16, ICP18 and IPC20
- INTTREG

Global interrupt control functions are controlled from INTCON1 and INTCON2. INTCON1 contains the Interrupt Nesting Disable (NSTDIS) bit, as well as the control and status flags for the processor trap sources. The INTCON2 register controls the external interrupt request signal behavior and the use of the AIV table.

The IFSx registers maintain all of the interrupt request flags. Each source of interrupt has a status bit, which is set by the respective peripherals or external signal, and is cleared via software.

The IECx registers maintain all of the interrupt enable bits. These control bits are used to individually enable interrupts from the peripherals or external signals.

The IPCx registers are used to set the Interrupt Priority Level for each source of interrupt. Each user interrupt source can be assigned to one of eight priority levels.

The INTTREG register contains the associated interrupt vector number and the new CPU Interrupt Priority Level, which are latched into the Vector Number (VECNUM<6:0>) and the Interrupt Level (ILR<3:0>) bit fields in the INTTREG register. The new Interrupt Priority Level is the priority of the pending interrupt.

The interrupt sources are assigned to the IFSx, IECx and IPCx registers in the same sequence listed in Table 8-2. For example, the INTO (External Interrupt 0) is depicted as having a vector number and a natural order priority of 0. The INTOIF status bit is found in IFS0<0>, the INTOIE enable bit in IEC0<0> and the INTOIP<2:0> priority bits are in the first position of IPC0 (IPC0<2:0>).

Although they are not specifically part of the interrupt control hardware, two of the CPU control registers contain bits that control interrupt functionality. The ALU STATUS Register (SR) contains the IPL<2:0> bits (SR<7:5>). These indicate the current CPU Interrupt Priority Level. The user may change the current CPU priority level by writing to the IPL bits.

The CORCON register contains the IPL3 bit, which together with the IPL<2:0> bits, also indicates the current CPU priority level. IPL3 is a read-only bit so that the trap events cannot be masked by the user's software.

All interrupt registers are described in Register 8-3 through Register 8-30, in the following sections.

PIC24F16KL402 FAMILY

REGISTER 8-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
—	—	T3GIF	—	—	—	—	—
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5 **T3GIF:** Timer3 External Gate Interrupt Flag Status bit

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 4-0 **Unimplemented:** Read as '0'

REGISTER 8-8: IFS3: INTERRUPT FLAG STATUS REGISTER 3

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	U-0
—	—	—	—	—	BCL2IF ⁽¹⁾	SSP2IF ⁽¹⁾	—
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-3 **Unimplemented:** Read as '0'

bit 2 **BCL2IF:** MSSP2 I²C™ Bus Collision Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 1 **SSP2IF:** MSSP2 SPI/I²C Event Interrupt Flag Status bit⁽¹⁾

1 = Interrupt request has occurred

0 = Interrupt request has not occurred

bit 0 **Unimplemented:** Read as '0'

Note 1: These bits are unimplemented on PIC24FXXKL10X and PIC24FXXKL20X devices.

PIC24F16KL402 FAMILY

9.3 Control Registers

The operation of the oscillator is controlled by three Special Function Registers (SFRs):

- OSCCON
- CLKDIV
- OSCTUN

The OSCCON register (Register 9-1) is the main control register for the oscillator. It controls clock source switching and allows the monitoring of clock sources.

The Clock Divider register (Register 9-2) controls the features associated with Doze mode, as well as the postscaler for the FRC oscillator.

The FRC Oscillator Tune register (Register 9-3) allows the user to fine-tune the FRC oscillator. OSCTUN functionality has been provided to help customers compensate for temperature effects on the FRC frequency over a wide range of temperatures. The tuning step-size is an approximation and is neither characterized nor tested.

REGISTER 9-1: OSCCON: OSCILLATOR CONTROL REGISTER

U-0	R-0, HSC	R-0, HSC	R-0, HSC	U-0	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾	R/W-x ⁽¹⁾
—	COSC2	COSC1	COSC0	—	NOSC2	NOSC1	NOSC0
bit 15				bit 8			

R/SO-0, HSC	U-0	R-0, HSC ⁽²⁾	U-0	R/CO-0, HS	R/W-0 ⁽³⁾	R/W-0	R/W-0
CLKLOCK	—	LOCK	—	CF	SOSCDRV	SOSCEN	OSWEN
bit 7				bit 0			

Legend:	HSC = Hardware Settable/Clearable bit		
HS = Hardware Settable bit	CO = Clearable Only bit	SO = Settable Only bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **COSC<2:0>:** Current Oscillator Selection bits

- 111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)
- 110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)
- 101 = Low-Power RC Oscillator (LPRC)
- 100 = Secondary Oscillator (SOSC)
- 011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)
- 010 = Primary Oscillator (XT, HS, EC)
- 001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)
- 000 = 8 MHz FRC Oscillator (FRC)

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **NOSC<2:0>:** New Oscillator Selection bits⁽¹⁾

- 111 = 8 MHz Fast RC Oscillator with Postscaler (FRCDIV)
- 110 = 500 kHz Low-Power Fast RC Oscillator (FRC) with Postscaler (LPFRCDIV)
- 101 = Low-Power RC Oscillator (LPRC)
- 100 = Secondary Oscillator (SOSC)
- 011 = Primary Oscillator with PLL module (XTPLL, HSPLL, ECPLL)
- 010 = Primary Oscillator (XT, HS, EC)
- 001 = 8 MHz FRC Oscillator with Postscaler and PLL module (FRCPLL)
- 000 = 8 MHz FRC Oscillator (FRC)

Note 1: Reset values for these bits are determined by the FNOSC<2:0> Configuration bits.

2: Also resets to '0' during any valid clock switch or whenever a non-PLL Clock mode is selected.

3: When SOSC is selected to run from a digital clock input rather than an external crystal (SOSCSRC = 0), this bit has no effect.

PIC24F16KL402 FAMILY

REGISTER 16-1: CCPxCON: CCPx CONTROL REGISTER (STANDARD CCP MODULES)

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DCxB1	DCxB0	CCPxM3 ⁽¹⁾	CCPxM2 ⁽¹⁾	CCPxM1 ⁽¹⁾	CCPxM0 ⁽¹⁾
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-6 **Unimplemented:** Read as '0'

bit 5-4 **DCxB<1:0>:** PWM Duty Cycle Bit 1 and Bit 0 for CCPx Module bits

Capture and Compare modes:

Unused.

PWM mode:

These bits are the two Least Significant bits (bit 1 and bit 0) of the 10-bit PWM duty cycle. The eight Most Significant bits (DCxB<9:2>) of the duty cycle are found in CCPRxL.

bit 3-0 **CCPxM<3:0>:** CCPx Module Mode Select bits⁽¹⁾

1111 = Reserved

1110 = Reserved

1101 = Reserved

1100 = PWM mode

1011 = Compare mode: Special Event Trigger; resets timer on CCPx match (CCPxIF bit is set)

1010 = Compare mode: Generates software interrupt on compare match (CCPxIF bit is set, CCPx pin reflects I/O state)

1001 = Compare mode: Initializes CCPx pin high; on compare match, forces CCPx pin low (CCPxIF bit is set)

1000 = Compare mode: Initializes CCPx pin low; on compare match, forces CCPx pin high (CCPxIF bit is set)

0111 = Capture mode: Every 16th rising edge

0110 = Capture mode: Every 4th rising edge

0101 = Capture mode: Every rising edge

0100 = Capture mode: Every falling edge

0011 = Reserved

0010 = Compare mode: Toggles output on match (CCPxIF bit is set)

0001 = Reserved

0000 = Capture/Compare/PWM is disabled (resets CCPx module)

Note 1: CCPxM<3:0> = 1011 will only reset the timer and not start the A/D conversion on a CCPx match.

PIC24F16KL402 FAMILY

REGISTER 16-6: CCPTMRS0: CCP TIMER SELECT CONTROL REGISTER 0⁽¹⁾

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15						bit 8	

U-0	R/W-0	U-0	U-0	R/W-0	U-0	U-0	R/W-0
—	C3TSEL0	—	—	C2TSEL0	—	—	C1TSEL0
bit 7						bit 0	

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6 **C3TSEL0:** CCP3 Timer Selection bit

1 = CCP3 uses TMR3/TMR4

0 = CCP3 uses TMR3/TMR2

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **C2TSEL0:** CCP2 Timer Selection bit

1 = CCP2 uses TMR3/TMR4

0 = CCP2 uses TMR3/TMR2

bit 2-1 **Unimplemented:** Read as '0'

bit 0 **C1TSEL0:** CCP1/ECCP1 Timer Selection bit

1 = CCP1/ECCP1 uses TMR3/TMR4

0 = CCP1/ECCP1 uses TMR3/TMR2

Note 1: This register is unimplemented on PIC24FXXKL20X/10X devices; maintain as '0'.

PIC24F16KL402 FAMILY

REGISTER 21-1: CVRCON: COMPARATOR VOLTAGE REFERENCE CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
CVREN	CVROE	CVRSS	CVR4	CVR3	CVR2	CVR1	CVR0
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **CVREN:** Comparator Voltage Reference Enable bit

1 = CVREF circuit is powered on

0 = CVREF circuit is powered down

bit 6 **CVROE:** Comparator VREF Output Enable bit

1 = CVREF voltage level is output on the CVREF pin

0 = CVREF voltage level is disconnected from the CVREF pin

bit 5 **CVRSS:** Comparator VREF Source Selection bit

1 = Comparator reference source, CVRSRC = VREF+ – VREF-

0 = Comparator reference source, CVRSRC = AVDD – AVSS

bit 4-0 **CVR<4:0>:** Comparator VREF Value Selection $0 \leq \text{CVR}<4:0> \leq 31$ bits

When CVRSS = 1:

$\text{CVREF} = (\text{VREF-}) + (\text{CVR}<4:0>/32) \cdot (\text{VREF+} - \text{VREF-})$

When CVRSS = 0:

$\text{CVREF} = (\text{AVSS}) + (\text{CVR}<4:0>/32) \cdot (\text{AVDD} - \text{AVSS})$

25.0 INSTRUCTION SET SUMMARY

Note: This chapter is a brief summary of the PIC24F Instruction Set Architecture (ISA) and is not intended to be a comprehensive reference source.

The PIC24F instruction set adds many enhancements to the previous PIC® MCU instruction sets, while maintaining an easy migration from previous PIC MCU instruction sets. Most instructions are a single program memory word. Only three instructions require two program memory locations.

Each single-word instruction is a 24-bit word divided into an 8-bit opcode, which specifies the instruction type and one or more operands, which further specify the operation of the instruction. The instruction set is highly orthogonal and is grouped into four basic categories:

- Word or byte-oriented operations
- Bit-oriented operations
- Literal operations
- Control operations

Table 25-1 lists the general symbols used in describing the instructions. The PIC24F instruction set summary in Table 25-2 lists all the instructions, along with the status flags affected by each instruction.

Most word or byte-oriented W register instructions (including barrel shift instructions) have three operands:

- The first source operand, which is typically a register 'Wb' without any address modifier
- The second source operand, which is typically a register 'Ws' with or without an address modifier
- The destination of the result, which is typically a register 'Wd' with or without an address modifier

However, word or byte-oriented file register instructions have two operands:

- The file register specified by the value, 'f'
- The destination, which could either be the file register, 'f', or the W0 register, which is denoted as 'WREG'

Most bit-oriented instructions (including simple rotate/shift instructions) have two operands:

- The W register (with or without an address modifier) or file register (specified by the value of 'Ws' or 'f')
- The bit in the W register or file register (specified by a literal value or indirectly by the contents of register, 'Wb')

The literal instructions that involve data movement may use some of the following operands:

- A literal value to be loaded into a W register or file register (specified by the value of 'k')
- The W register or file register where the literal value is to be loaded (specified by 'Wb' or 'f')

However, literal instructions that involve arithmetic or logical operations use some of the following operands:

- The first source operand, which is a register 'Wb' without any address modifier
- The second source operand, which is a literal value
- The destination of the result (only if not the same as the first source operand), which is typically a register 'Wd' with or without an address modifier

The control instructions may use some of the following operands:

- A program memory address
- The mode of the Table Read and Table Write instructions

All instructions are a single word, except for certain double-word instructions, which were made double-word instructions so that all of the required information is available in these 48 bits. In the second word, the 8 MSBs are '0's. If this second word is executed as an instruction (by itself), it will execute as a NOP.

Most single-word instructions are executed in a single instruction cycle, unless a conditional test is true or the Program Counter (PC) is changed as a result of the instruction. In these cases, the execution takes two instruction cycles, with the additional instruction cycle(s) executed as a NOP. Notable exceptions are the BRA (unconditional/computed branch), indirect CALL/GOTO, all Table Reads and Table Writes, and RETURN/RETFIE instructions, which are single-word instructions but take two or three cycles.

Certain instructions that involve skipping over the subsequent instruction require either two or three cycles if the skip is performed, depending on whether the instruction being skipped is a single-word or two-word instruction. Moreover, double-word moves require two cycles. The double-word instructions execute in two instruction cycles.

PIC24F16KL402 FAMILY

TABLE 25-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
GOTO	GOTO Expr	Go to Address	2	2	None
	GOTO Wn	Go to Indirect	1	2	None
INC	INC f	$f = f + 1$	1	1	C, DC, N, OV, Z
	INC f, WREG	WREG = $f + 1$	1	1	C, DC, N, OV, Z
	INC Ws, Wd	Wd = Ws + 1	1	1	C, DC, N, OV, Z
INC2	INC2 f	$f = f + 2$	1	1	C, DC, N, OV, Z
	INC2 f, WREG	WREG = $f + 2$	1	1	C, DC, N, OV, Z
	INC2 Ws, Wd	Wd = Ws + 2	1	1	C, DC, N, OV, Z
IOR	IOR f	$f = f . \text{IOR. WREG}$	1	1	N, Z
	IOR f, WREG	WREG = $f . \text{IOR. WREG}$	1	1	N, Z
	IOR #lit10, Wn	Wd = lit10 .IOR. Wd	1	1	N, Z
	IOR Wb, Ws, Wd	Wd = Wb .IOR. Ws	1	1	N, Z
	IOR Wb, #lit5, Wd	Wd = Wb .IOR. lit5	1	1	N, Z
LNK	LNK #lit14	Link Frame Pointer	1	1	None
LSR	LSR f	$f = \text{Logical Right Shift } f$	1	1	C, N, OV, Z
	LSR f, WREG	WREG = Logical Right Shift f	1	1	C, N, OV, Z
	LSR Ws, Wd	Wd = Logical Right Shift Ws	1	1	C, N, OV, Z
	LSR Wb, Wns, Wnd	Wnd = Logical Right Shift Wb by Wns	1	1	N, Z
	LSR Wb, #lit5, Wnd	Wnd = Logical Right Shift Wb by lit5	1	1	N, Z
MOV	MOV f, Wn	Move f to Wn	1	1	None
	MOV [Wns+Slit10], Wnd	Move [Wns+Slit10] to Wnd	1	1	None
	MOV f	Move f to f	1	1	N, Z
	MOV f, WREG	Move f to WREG	1	1	None
	MOV #lit16, Wn	Move 16-bit Literal to Wn	1	1	None
	MOV.b #lit8, Wn	Move 8-bit Literal to Wn	1	1	None
	MOV Wn, f	Move Wn to f	1	1	None
	MOV Wns, [Wns+Slit10]	Move Wns to [Wns+Slit10]	1	1	None
	MOV Wso, Wdo	Move Ws to Wd	1	1	None
	MOV WREG, f	Move WREG to f	1	1	None
	MOV.D Wns, Wd	Move Double from W(ns):W(ns+1) to Wd	1	2	None
	MOV.D Ws, Wnd	Move Double from Ws to W(nd+1):W(nd)	1	2	None
MUL	MUL.SS Wb, Ws, Wnd	{Wnd+1, Wnd} = Signed(Wb) * Signed(Ws)	1	1	None
	MUL.SU Wb, Ws, Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(Ws)	1	1	None
	MUL.US Wb, Ws, Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Signed(Ws)	1	1	None
	MUL.UU Wb, Ws, Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(Ws)	1	1	None
	MUL.SU Wb, #lit5, Wnd	{Wnd+1, Wnd} = Signed(Wb) * Unsigned(lit5)	1	1	None
	MUL.UU Wb, #lit5, Wnd	{Wnd+1, Wnd} = Unsigned(Wb) * Unsigned(lit5)	1	1	None
	MUL f	W3:W2 = $f * \text{WREG}$	1	1	None
NEG	NEG f	$f = \bar{f} + 1$	1	1	C, DC, N, OV, Z
	NEG f, WREG	WREG = $\bar{f} + 1$	1	1	C, DC, N, OV, Z
	NEG Ws, Wd	Wd = $\overline{\text{Ws}} + 1$	1	1	C, DC, N, OV, Z
NOP	NOP	No Operation	1	1	None
	NOPR	No Operation	1	1	None
POP	POP f	Pop f from Top-of-Stack (TOS)	1	1	None
	POP Wdo	Pop from Top-of-Stack (TOS) to Wdo	1	1	None
	POP.D Wnd	Pop from Top-of-Stack (TOS) to W(nd):W(nd+1)	1	2	None
	POP.S	Pop Shadow Registers	1	1	All
PUSH	PUSH f	Push f to Top-of-Stack (TOS)	1	1	None
	PUSH Wso	Push Wso to Top-of-Stack (TOS)	1	1	None
	PUSH.D Wns	Push W(ns):W(ns+1) to Top-of-Stack (TOS)	1	2	None
	PUSH.S	Push Shadow Registers	1	1	None

PIC24F16KL402 FAMILY

TABLE 25-2: INSTRUCTION SET OVERVIEW (CONTINUED)

Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
TBLRDH	TBLRDH <i>Ws, Wd</i>	Read Prog<23:16> to Wd<7:0>	1	2	None
TBLRDL	TBLRDL <i>Ws, Wd</i>	Read Prog<15:0> to Wd	1	2	None
TBLWTH	TBLWTH <i>Ws, Wd</i>	Write Ws<7:0> to Prog<23:16>	1	2	None
TBLWTL	TBLWTL <i>Ws, Wd</i>	Write Ws to Prog<15:0>	1	2	None
ULNK	ULNK	Unlink Frame Pointer	1	1	None
XOR	XOR <i>f</i>	$f = f \text{ .XOR. WREG}$	1	1	N, Z
	XOR <i>f, WREG</i>	$WREG = f \text{ .XOR. WREG}$	1	1	N, Z
	XOR <i>#lit10, Wn</i>	$Wd = \text{lit10} \text{ .XOR. } Wd$	1	1	N, Z
	XOR <i>Wb, Ws, Wd</i>	$Wd = Wb \text{ .XOR. } Ws$	1	1	N, Z
	XOR <i>Wb, #lit5, Wd</i>	$Wd = Wb \text{ .XOR. lit5}$	1	1	N, Z
ZE	ZE <i>Ws, Wnd</i>	$Wnd = \text{Zero-Extend } Ws$	1	1	C, Z, N

PIC24F16KL402 FAMILY

TABLE 26-4: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)								
Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for Extended								
Param No.	Symbol	Characteristic		Min	Typ	Max	Units	Conditions
DC18	VHLVD	HLVD Voltage on VDD Transition	HLVDL<3:0> = 0000	—	1.85	1.94	V	
			HLVDL<3:0> = 0001	1.81	1.90	2.00	V	
			HLVDL<3:0> = 0010	1.85	1.95	2.05	V	
			HLVDL<3:0> = 0011	1.90	2.00	2.10	V	
			HLVDL<3:0> = 0100	1.95	2.05	2.15	V	
			HLVDL<3:0> = 0101	2.06	2.17	2.28	V	
			HLVDL<3:0> = 0110	2.12	2.23	2.34	V	
			HLVDL<3:0> = 0111	2.24	2.36	2.48	V	
			HLVDL<3:0> = 1000	2.31	2.43	2.55	V	
			HLVDL<3:0> = 1001	2.47	2.60	2.73	V	
			HLVDL<3:0> = 1010	2.64	2.78	2.92	V	
			HLVDL<3:0> = 1011	2.74	2.88	3.02	V	
			HLVDL<3:0> = 1100	2.85	3.00	3.15	V	
			HLVDL<3:0> = 1101	2.96	3.12	3.28	V	
			HLVDL<3:0> = 1110	3.22	3.39	3.56	V	

TABLE 26-5: BOR TRIP POINTS

Standard Operating Conditions: 1.8V to 3.6V								
Operating temperature		-40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended						
Param No.	Symbol	Characteristic		Min	Typ	Max	Units	Conditions
DC19		BOR Voltage on VDD Transition	BORV = 00	1.85	2.0	2.15	V	Note 1
			BORV = 01	2.90	3.0	3.38	V	
			BORV = 10	2.53	2.7	3.07	V	
			BORV = 11	1.75	1.85	2.05	V	

Note 1: LPBOR re-arms the POR circuit but does not cause a BOR.

PIC24F16KL402 FAMILY

FIGURE 26-6: CAPTURE/COMPARE/PWM TIMINGS (ECCP1, ECCP2 MODULES)

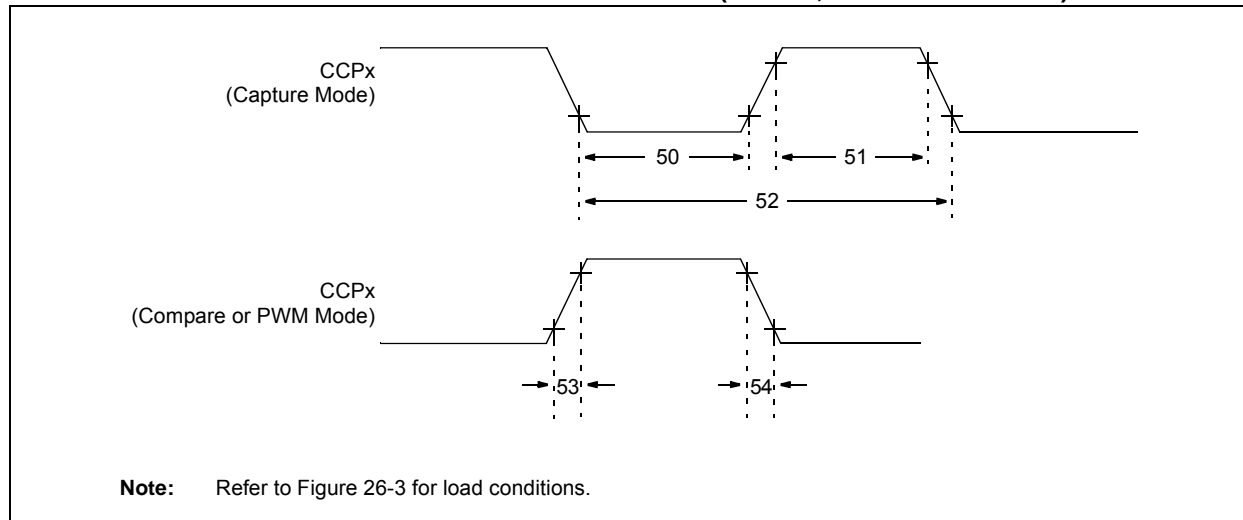


TABLE 26-26: CAPTURE/COMPARE/PWM REQUIREMENTS (ECCP1, ECCP2 MODULES)

Param No.	Symbol	Characteristic		Min	Max	Units	Conditions
50	TccL	CCPx Input Low Time	No Prescaler	$0.5 T_{CY} + 20$	—	ns	
			With Prescaler	20	—	ns	
51	TccH	CCPx Input High Time	No Prescaler	$0.5 T_{CY} + 20$	—	ns	
			With Prescaler	20	—	ns	
52	TccP	CCPx Input Period		Greater of: 40 or $\frac{2 T_{CY} + 40}{N}$	—	ns	N = prescale value (1, 4 or 16)
53	TccR	CCPx Output Fall Time		—	25	ns	
54	TccF	CCPx Output Fall Time		—	25	ns	

PIC24F16KL402 FAMILY

FIGURE 26-13: MSSPx I²C™ BUS START/STOP BITS TIMING WAVEFORMS

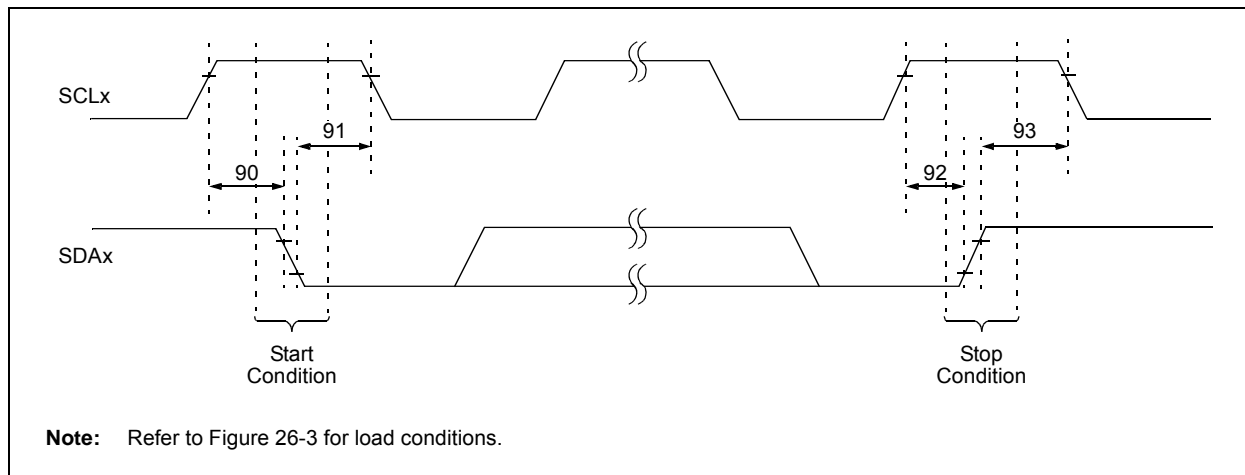


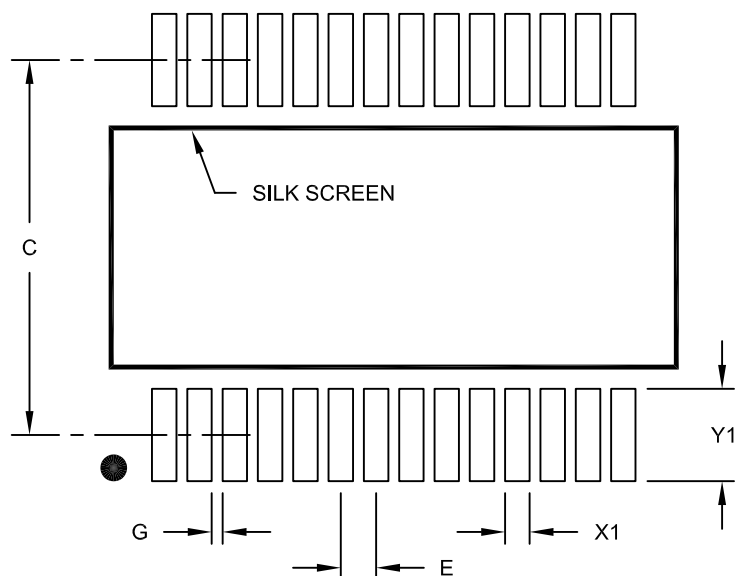
TABLE 26-33: I²C™ BUS START/STOP BITS REQUIREMENTS (MASTER MODE)

Param. No.	Symbol	Characteristic		Min	Max	Units	Conditions
90	TSU:STA	Start Condition Setup Time	100 kHz mode	$2(T_{osc})(BRG + 1)$	—	ns	Only relevant for Repeated Start condition
			400 kHz mode	$2(T_{osc})(BRG + 1)$	—		
91	THD:STA	Start Condition Hold Time	100 kHz mode	$2(T_{osc})(BRG + 1)$	—	ns	After this period, the first clock pulse is generated
			400 kHz mode	$2(T_{osc})(BRG + 1)$	—		
92	TSU:STO	Stop Condition Setup Time	100 kHz mode	$2(T_{osc})(BRG + 1)$	—	ns	
			400 kHz mode	$2(T_{osc})(BRG + 1)$	—		
93	THD:STO	Stop Condition Hold Time	100 kHz mode	$2(T_{osc})(BRG + 1)$	—	ns	
			400 kHz mode	$2(T_{osc})(BRG + 1)$	—		

PIC24F16KL402 FAMILY

28-Lead Plastic Shrink Small Outline (SS) - 5.30 mm Body [SSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C		7.20	
Contact Pad Width (X28)	X1			0.45
Contact Pad Length (X28)	Y1			1.75
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2073A

PIC24F16KL402 FAMILY

APPENDIX A: REVISION HISTORY

Revision A (September 2011)

Original data sheet for the PIC24F16KL402 family of devices.

Revision B (November 2011)

Updates DC Specifications in Tables 26-6 through 26-9 (all Typical and Maximum values).

Updates AC Specifications in Tables 26-7 through 26-30 (SPI Timing Requirements) with the addition of the FSK specification.

Other minor typographic corrections throughout.

Revision C (October 2013)

Adds +125°C Extended Temperature information.

Updates several packaging drawings in **Section 27.0 “Packaging Information”**. Other minor typographic corrections throughout.

APPENDIX B: MIGRATING FROM PIC18/PIC24 TO PIC24F16KL402

The PIC24F16KL402 family combines traditional PIC18 peripherals with a faster PIC24 core to provide a low-cost, high-performance microcontroller with low-power consumption.

Code written for PIC18 devices can be migrated to the PIC24F16KL402 by using a C compiler that generates PIC24 machine level instructions. Assembly language code will need to be rewritten using PIC24 instructions. The PIC24 instruction set shares similarities to the PIC18 instruction set, which should ease porting of assembly code. Application code will require changes to support certain PIC24 peripherals.

Code written for PIC24 devices can be migrated to the PIC24F16KL402 without many code changes. Certain peripherals, however, will require application changes to support modules that were traditionally available only on PIC18 devices.

Refer to Table B-1 for a list of peripheral modules on the PIC24F16KL402 and where they originated from.

TABLE B-1: TABLE B-1: PIC24F16KL402 PERIPHERAL MODULE ORIGINATING ARCHITECTURE

Peripheral Module	PIC18	PIC24
ECCP/CCP	X	—
MSSP (I ² C™/SPI)	X	—
Timer2/4 (8-bit)	X	—
Timer3 (16-bit)	X	—
Timer1 (16-bit)	—	X
10-Bit A/D Converter	—	X
Comparator	—	X
Comparator Voltage Reference	—	X
UART	—	X
HLVD	—	X

PIC24F16KL402 FAMILY

INDEX

A

A/D

10-Bit High-Speed A/D Converter	157
Conversion Timing Requirements	224
Module Specifications	223

A/D Converter

Analog Input Model	164
Transfer Function	165

AC Characteristics

A/D Module	223
Capacitive Loading Requirements on Output Pins	209
Internal RC Oscillator Accuracy	211
Internal RC Oscillator Specifications	211
Load Conditions and Requirements	209
Temperature and Voltage Specifications	209

Assembler

MPASM Assembler	188
-----------------------	-----

B

Block Diagrams

10-Bit High-Speed A/D Converter	158
16-Bit Timer1	115
Accessing Program Memory with Table Instructions	45
CALL Stack Frame	43
Capture Mode Operation	126
Comparator Module	167
Comparator Voltage Reference Module	171
Compare Mode Operation	126
CPU Programmer's Model	27
Data Access From Program Space Address Generation	44
Data EEPROM Addressing with TBLPAG and NVM Registers	55
Enhanced PWM Mode	127
High/Low-Voltage Detect (HLVD) Module	173
Individual Comparator Configurations	168
MCLR Pin Connections Example	22
MSSPx Module (I ² C Master Mode)	137
MSSPx Module (I ² C Mode)	137
MSSPx Module (SPI Mode)	136
PIC24F CPU Core	26
PIC24F16KL402 Family (General)	13
PSV Operation	46
PWM Operation (Simplified)	126
Recommended Minimum Connections	21
Reset System	59
Serial Resistor	107
Shared I/O Port Structure	111
Simplified UARTx	149
SPI Master/Slave Connection	136
Suggested Placement of Oscillator Circuit	23
System Clock	95
Table Register Addressing	47
Timer2	117
Timer3	119
Timer4	123
Watchdog Timer (WDT)	184

C

C Compilers

MPLAB XC Compilers	188
Capture/Compare/PWM (CCP)	125
CCP/ECCP CCP I/O Pins	125
Timer Selection	125

Code Examples

Data EEPROM Bulk Erase	57
Data EEPROM Unlock Sequence	53
Erasing a Program Memory Row, Assembly Language	50
Erasing a Program Memory Row, C Language	51
I/O Port Write/Read (Assembly Language)	114
I/O Port Write/Read (C Language)	114
Initiating a Programming Sequence, Assembly Language	52
Initiating a Programming Sequence, C Language	52
Loading the Write Buffers, Assembly Language	51
Loading the Write Buffers, C Language	52
PWRSV Instruction Syntax	105
Reading Data EEPROM Using the TBLRD Command	58
Sequence for Clock Switching	102
Single-Word Erase	56
Single-Word Write to Data EEPROM	57
Ultra Low-Power Wake-up Initialization	107
Code Protection	185
Comparator	167
Comparator Voltage Reference	171
Configuring	171
Configuration Bits	175
Core Features	9
CPU ALU	29
Control Registers	28
Core Registers	26
Programmer's Model	25
Customer Change Notification Service	257
Customer Notification Service	257
Customer Support	257

D

Data EEPROM Memory	53
Erasing	56
Nonvolatile Memory Registers NVMCON	53
NVMKEY	53
NVMADR(U)	55
Operations	55
Programming Bulk Erase	57
Reading Data EEPROM	58
Single-Word Write	57
Data Memory Address Space	33
Memory Map	33
Near Data Space	34
Organization	34
SFR Space	34
Software Stack	43
Space Width	33

PIC24F16KL402 FAMILY

NOTES: